### Name of the Department/Centre: Physics

### **Course Type (Please tick appropriate box):**

Major Minor Value Added Discipline Specific Core Multidisciplinary

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 X

 Any other

Ability Enhancement Skill Enhancement

Semester - II

**Course Title – Experimental Techniques** 

**Course Type – Multidisciplinary Course** 

Course Code - 24-PHY-T-156

Maximum Marks: 100

Course Level - 100

Total Credits – 3

Classes /week - 3

Prerequisite – Physics in class XII

Course Advisor's Name :

Course Advisor's Email :

## **Expected Learning Outcome –**

After completing this course, the students will be able to -

- 1. Apply measurement principles and data analysis techniques.
- 2. Understand signal processing and system response.
- 3. Design and characterize thin film materials.
- 4. Develop vacuum systems for various applications.

5. Integrate knowledge of measurement, signals, and materials for industrial applications.

## **Reference Books:**

- 1. Electrical Measurements & Electronic Measurements : A.K. Sawhney
- 2. Modern electronic Instrumentation and measurement techniques : Helfrick Cooper
- 3. Electronic test instruments: analog and digital measurements: R. A. Witte
- 4. Instrumentation, devices and systems : Rangan, Sarma and Mani
- 5. Electronic Instrumentation : H. S. Kalsi .

#### **Course Syllabus**

## Unit I: Measurements and Data processing

Accuracy and precision. Significant figures. Error and uncertainty analysis. Types of errors: Gross error, systematic error, random error. Statistical analysis of data (Arithmetic mean, deviation from mean, average deviation, standard deviation, chi-square) and curve fitting. Guassian distribution.

Recording and analysis of data, data uncertainty, Error: - accuracy and precision, computeraided data acquisition

# Unit II: Signals, Systems and Shielding

Periodic and aperiodic signals. Impulse response, transfer function and frequency response of first and second order systems. Fluctuations and Noise in measurement system. S/N ratio and Noise figure. Noise in frequency domain. Sources of Noise: Inherent fluctuations, Thermal noise, Shot noise, 1/f noise, Methods of safety grounding. Energy coupling. Grounding. Shielding: Electrostatic shielding. Electromagnetic Interference.

# Unit III: Thin Film Growth and Characterization Techniques

Physical vapour deposition, thermal evaporation, e-beam evaporation, sputtering, pulsed laser deposition, molecular beam epitaxy, MOCVD, thin film technology for industrial applications. UV-Vis absorption spectroscopy, FTIR spectroscopy, Photoluminscence.

## **Unit IV: Vacuum Systems**

Characteristics of vacuum: Gas law, Mean free path. Application of vacuum. Vacuum system-Chamber, Mechanical pumps, Diffusion pump & Turbo Modular pump, Pumping speed, Pressure gauges (Pirani, Penning, ionization)